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(12) **United States Design Patent**
Chung

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(45) **Date of Patent:** **** Feb. 14, 2017**

(54) **GROUNDING CONDUCTOR**

CPC H01R 4/66
See application file for complete search history.

(71) Applicant: **OMNI LPS. CO., LTD.**, Seoul (KR)

(56) **References Cited**

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U.S. PATENT DOCUMENTS

(73) Assignee: **OMNI LPS. CO., LTD.**, Seoul (KR)

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174/102 SC
D709,781 S * 7/2014 Chung D10/105

(**) Term: **15 Years**

* cited by examiner

(21) Appl. No.: **29/539,927**

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Mueller & Larson, P.C.

(22) Filed: **Sep. 18, 2015**

(57) **CLAIM**

The ornamental design for a grounding conductor, as shown.

(30) **Foreign Application Priority Data**

DESCRIPTION

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FIG. 1 is a front perspective view of the grounding conductor;

(51) **LOC (10) Cl.** **10-05**

FIG. 2 is a front elevation view of the grounding conductor;

(52) **U.S. Cl.**

FIG. 3 is a rear elevation view of the grounding conductor;

USPC **D10/105**

FIG. 4 is a left-side view of the grounding conductor;

(58) **Field of Classification Search**

FIG. 5 is a right-side view of the grounding conductor;

USPC D10/105; D13/117, 101, 184, 199

FIG. 6 is a top plan view of the grounding conductor; and,

FIG. 7 is a bottom plan view of the grounding conductor.

1 Claim, 5 Drawing Sheets

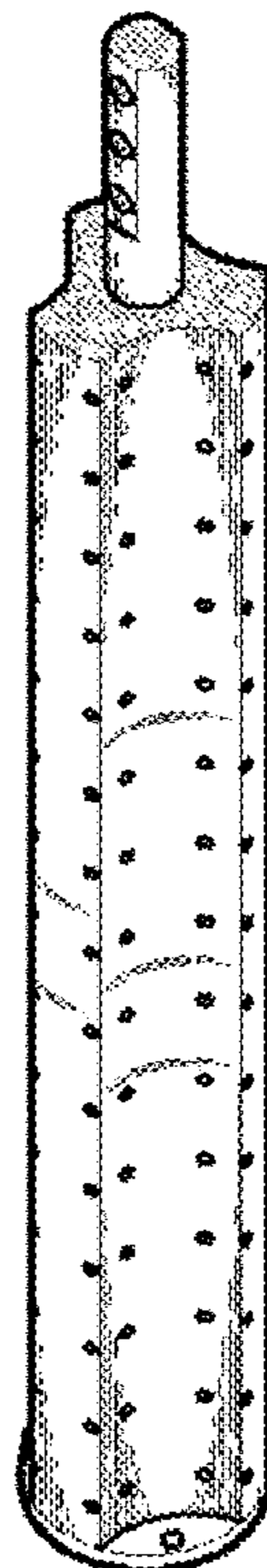


FIG. 1

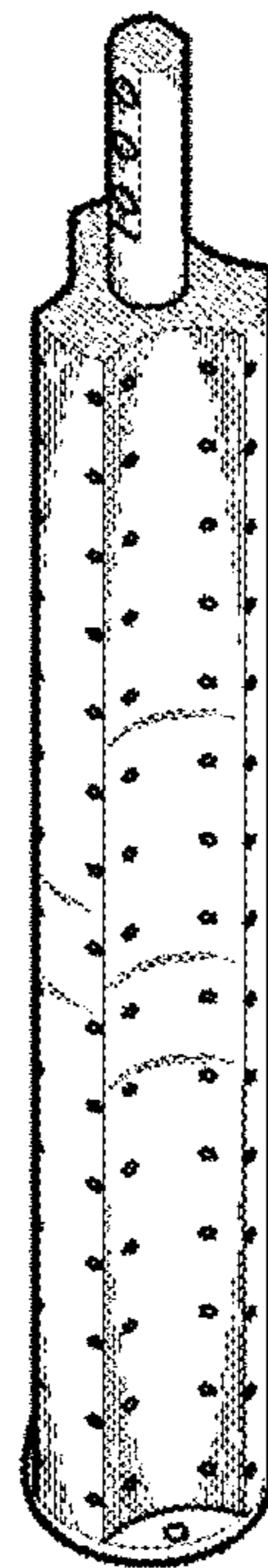


FIG. 2

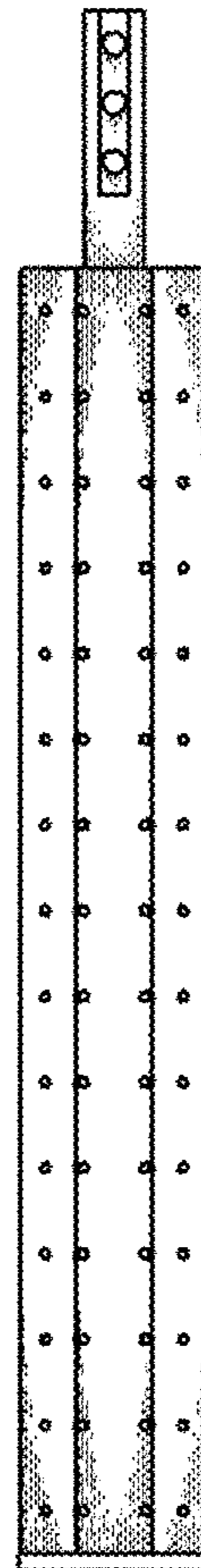


FIG. 3

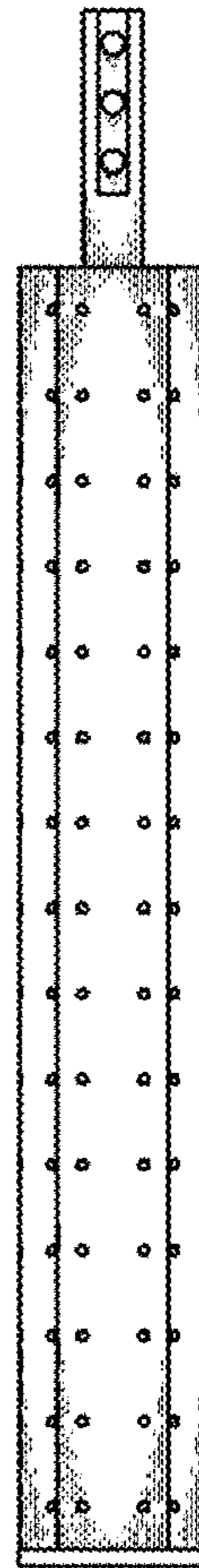


FIG. 4

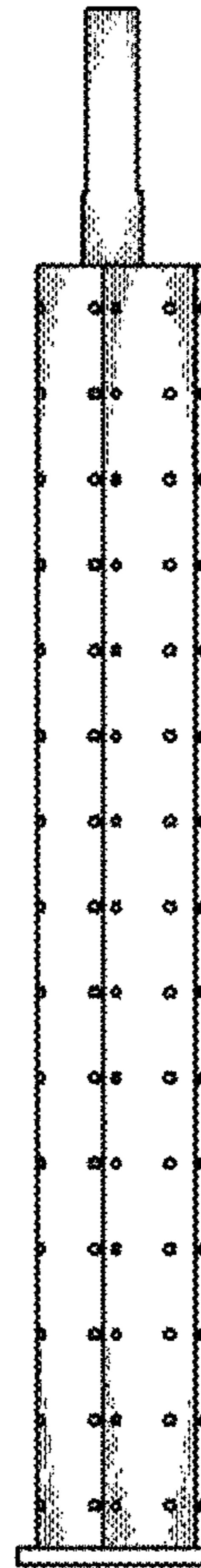


FIG. 5

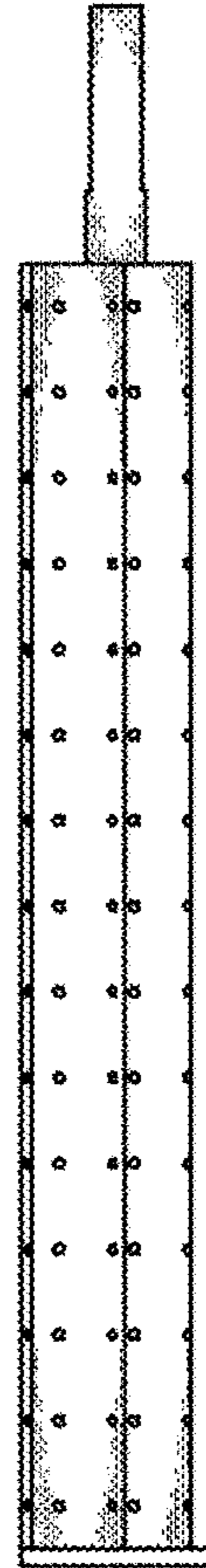


FIG. 6

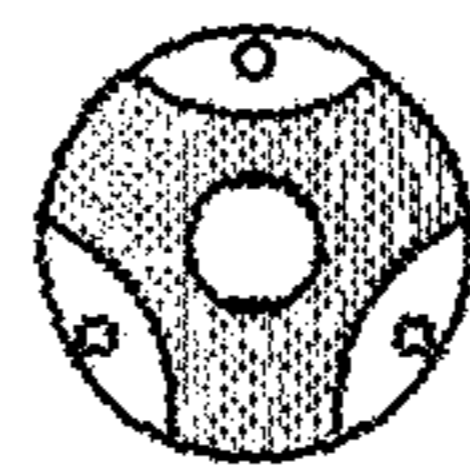


FIG. 7

